

BD034

WR0459I

SQS

			℃
			℃

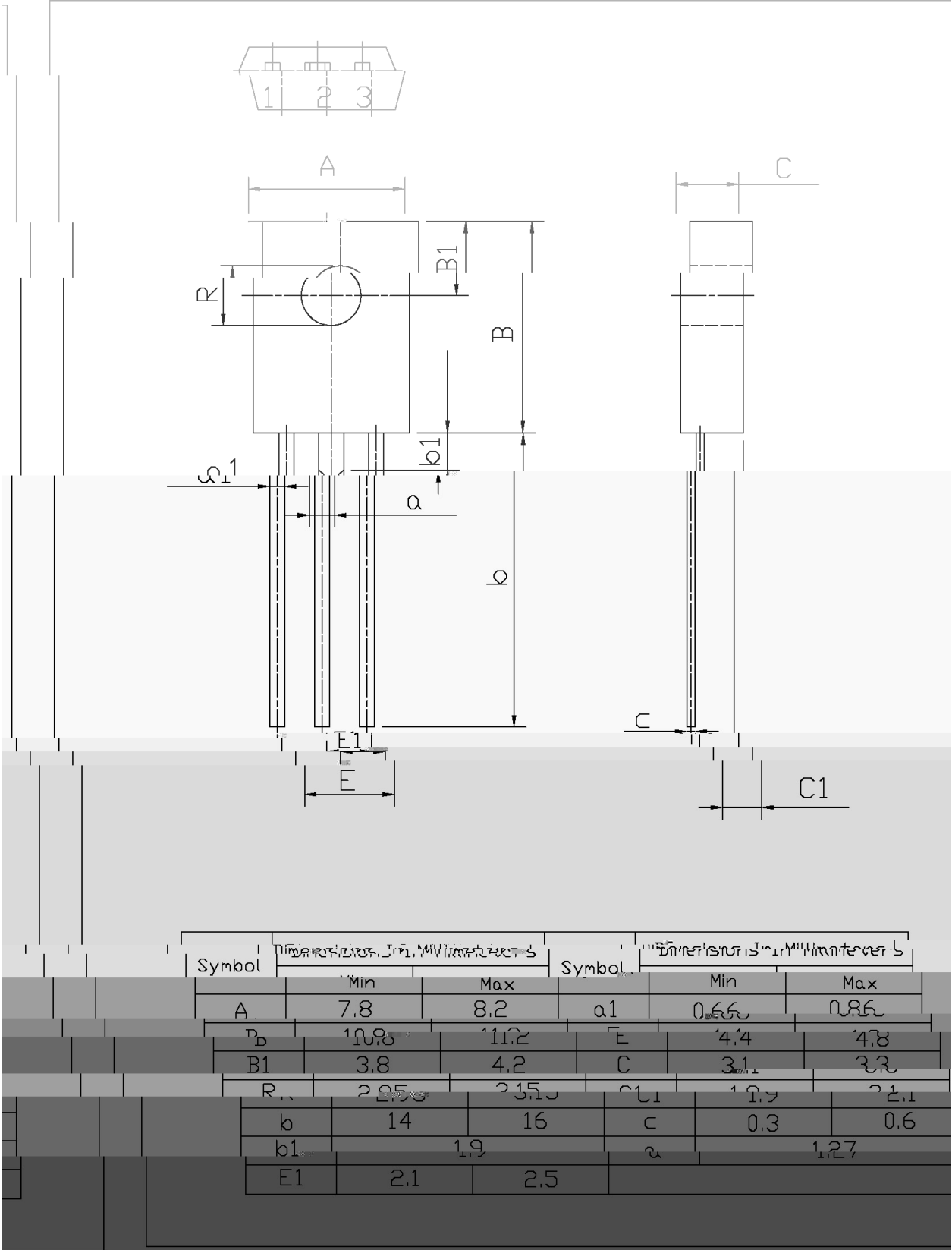
		μ				

BD034

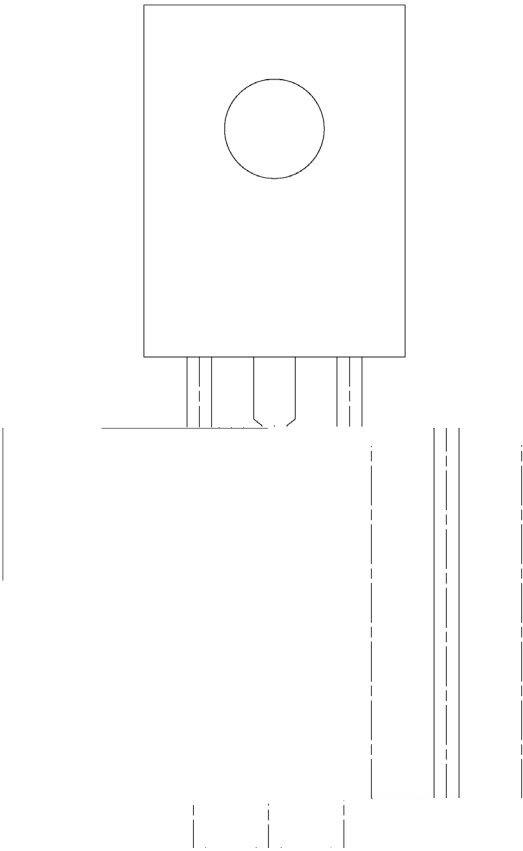
/ Package Dimensions

BU-126T

单位: mm

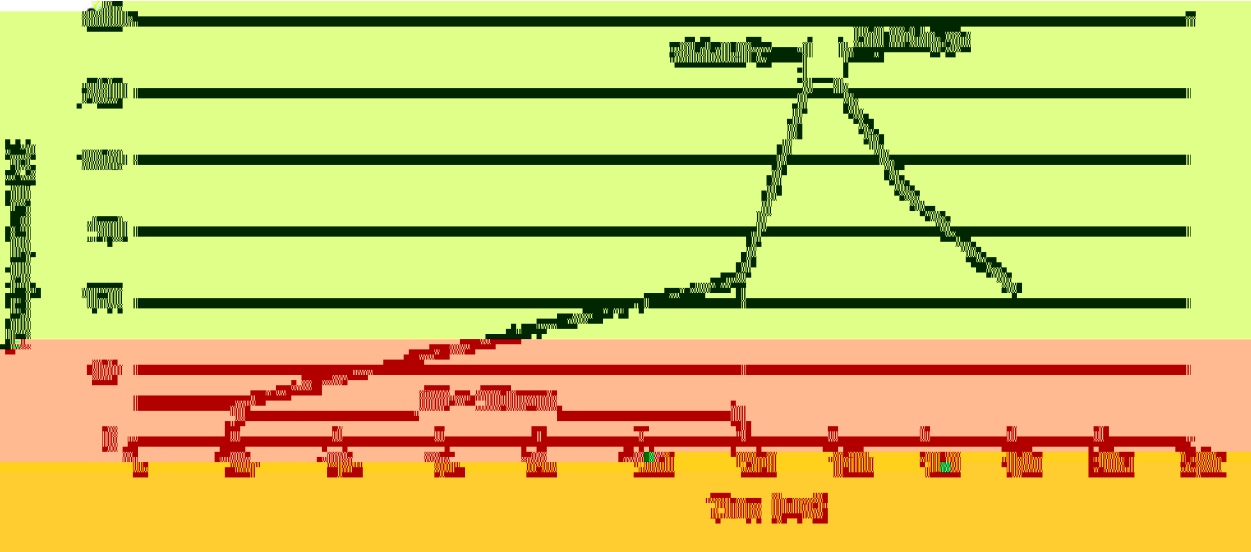


/ Marking Instructions



EU
EG367
U k_{IH}

() / Temperature Profile for Dip Soldering(Pb-Free)



$\frac{3}{8}$

2 $\frac{3}{8}$

$\frac{3}{8}$

2

$\frac{3}{8}$

2 $\frac{3}{8}$

$\frac{3}{8}$

2

/ Resistance to Soldering Heat Test Conditions

2 $\frac{3}{8}$

2

℃

/ Packaging SPEC.

封装形式		包装数量		包装尺寸		:
	只 套管		套管 盒		只 盒	